

Process Change Notification

Date: May 22, 2012
PCN Reference: S13232
Product Reference: SOIC8L BCD7

Dear Valued Customer,

As always we appreciate your use of International Rectifier semiconductor products. Our commitment to customer satisfaction and continuous improvement is demonstrated by our change plans to enhance capacity, quality and reliability. This notice is to inform you of the following change:

Type of Change Notification:

New assembly site for the assembly of Pb-free SOIC8L-BCD7 Products.

Description of Change:

Unisem Indonesia has been qualified as alternate assembly site for the Products identified in the following page. The Bill of Materials at this alternate site will be as follows:

Epoxy	QMI519
Wire	Cu wire
Mold compound	CEL8240HF10

Reason for the Change:

Increase assembly capacity.

Effect Date:

August 31, 2012

International Rectifier will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. Please submit conditions of acceptance to the PCN Coordinator listed at the end of this notice.

Impact of Change:

There will be no change in form fit, function, quality, or reliability. Datasheet specifications and major electrical characteristics will remain unchanged.

Products Affected:

IR11452STRPBF	IR11452SPBF
IR3519STRPBF	IR3519SPBF
IR1155STRPBF	IR1155SPBF
IR1152STRPBF	IR1152SPBF
IR1153STRPBF	IR1153SPBF

Qualification:

Parts passed all the reliability testing requirements. Reliability qualification report will be available upon the completion of reliability testing. Qualification standards can be found on International Rectifier's web site at www.irf.com/product-info/reliability.

Sample Availability:

Representative samples are available through PCN coordinator

Contact Information:

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